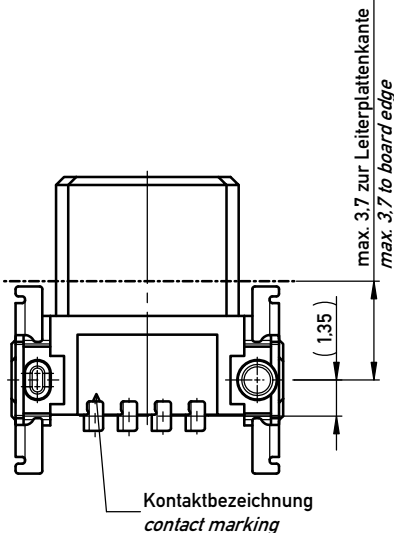
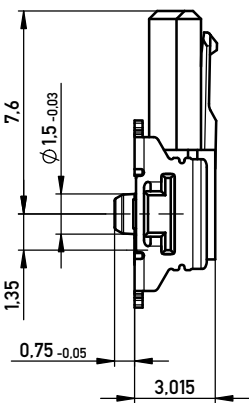
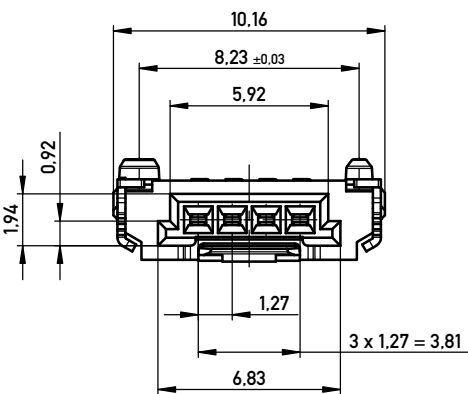
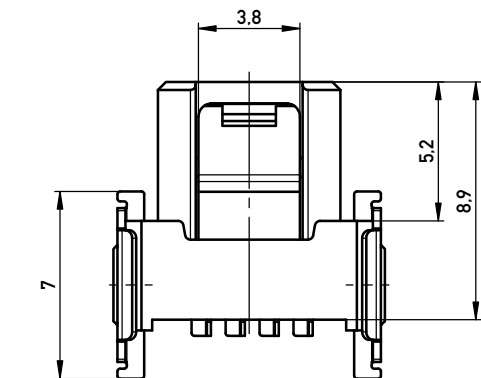
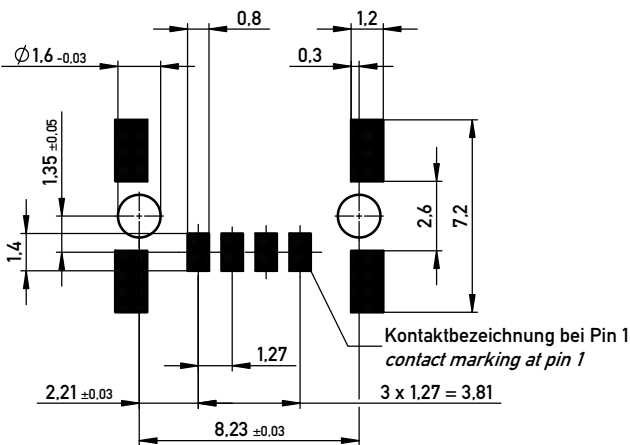
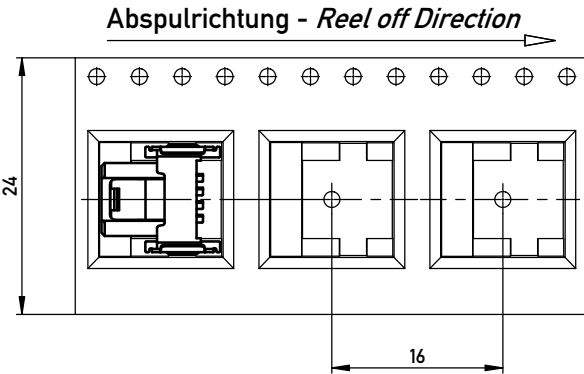
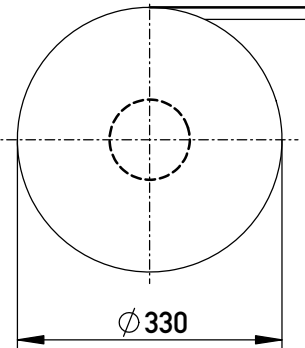


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 850 Stück
Packaging unit: 850 pcs



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 μ m
Terminal Area 4-6 μ m tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

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Information: ohne Hilfsmittel lösbar without tool unlockable				Tolerances		 All Dimensions in mm		Scale 5:1	
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						F 1.27 SRC P, 4-polig BA1			
						364485			
b		15.07.2015		www.ERNI.com		I		A3	
Index		Date				Class		SRCP	

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